650V 15A N-Channel Enhancement Mode Power MOSFET

General Description

BXP15N65 is Bridgelux high voltage MOSFET family based on advanced planar DMOS technology. This advanced MOSFET family has optimized on-state resistance, and also provides superior switching performance and higher avalanche energy strength. This device family is suitable for high efficiency switch mode power supplies.

SYMBOL







TO-220F

ASSEMBLY MESSAGE

Product Name	Package	Packaging
BXP15N65P	TO-220	Tube
BXP15N65F	TO-220F	Tube

ABSOLUTE MAXIMUM RATINGS (T_c=25°C unless otherwise noted)

Parameter		Symbol –	Rati	Unit	
			BXP15N65P	BXP15N65F	Unit
Drain-Source Voltage		V _{DSS}	650		V
Drain Current	Continuous (T _c = 25°C)		15		A
Drain Current	Continuous (T _c = 100°C)	- I _D -	9.5		A
Drain Current	Pulsed (Note1)	I _{DM}	60		A
Gate-Source Voltage		V _{GSS}	±30		V
Avalanche Energy	Single Pulse (Note2)	E _{AS}	E _{AS} 950		mJ
Avalanche Current (Note1)		I _{AR}	15		Α
Peak Diode Recovery dv/dt (Note3)		dv/dt	4.5		V/ns
Power Dissipation (Note	T _C =25°C	Р	245	53	W
2)	Derate above 25°C	- P _D -	1.96	0.42	W/°C
Maximum Junction Temperature		TJ	150		°C
Storage Temperature Range		Tstg	-55 to 150		°C

Note: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. L=8.4mH, I_{AS}=15.0A, V_{DD}=50V, RG=25 Ω , Starting TJ = 25°C

3. I_{SD} ≤ 15.0A, di/dt ≤ 300A/µs, V_{DD} ≤ BV_{DSS}, Starting TJ = 25°C

FEATURES

- RDSON≤0.7 Ω @Vgs=10V, Id=7.5A
- Excellent RDS(ON) and Low Gate Charge
- Fast switching capability
- Lead free product is acquired

BXP15N65



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THERMAL CHARACTERISTICS

Deremeter	Symbol	Ma	llmit	
Parameter	Symbol	BXP15N65P	BXP15N65F	Unit
Thermal Resistance, Junction-to-Case	R _{θJC}	0.51	2.36	°C / W
Thermal Resistance, Junction-to-Ambient	R _{0JA}	62.5	62.5	°C / W

ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise Noted)

Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
OFF CHARACTERISTICS	I	L I				
Drain-Source Breakdown Voltage	BV _{DSS}	VGS=0V, ID=250µA	650			V
	I _{DSS}	VDS=650V, VGS=0V			1	uA
Zero Gate Voltage Drain Current		VDS=520V, TC = 125°C			100	uA
Gate-Body Leakage Current, Forward		VGS=30V			100	nA
Gate-Body Leakage Current, Reverse	- I _{GSS}	VGS=-30V			-100	nA
Breakdown Voltage Temperature	∆BVDSS/			0.07		
Coefficient	∆TJ	ID = 250 μA		0.67		V/℃
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(TH)}	VDS=VGS, ID=250µA	2		4	V
Drain-Source On-State Resistance	RDS(ON)	VGS=10V, ID=7.5A		0.6	0.7	Ω
Forward Transconductance (Note4)	g⊧s	VDS = 50V, ID=7.5A		10		S
DYNAMIC PARAMETERS				1		
Input Capacitance	C _{ISS}			2460		pF
Output Capacitance	Coss	VDS=25V, VGS=0V,		205		pF
Reverse Transfer Capacitance	Crss	f=1.0MHz		12		pF
SWITCHING PARAMETERS						
Turn-ON Delay Time	t _{D(ON)}			49		ns
Turn-ON Rise Time	t _R	VDD=325V, ID=15A, VGS		117		ns
Turn-OFF Delay Time	t _{D(OFF)}	= 10V ,RG=25Ω		65		ns
Turn-OFF Fall-Time	t _F	(Note4,5)		42		ns
Total Gate Charge(Note5)	Q _G	VDS =520V, VGS =10V, ID		35		nC
Gate Source Charge	Q _{GS}	=15A		12		nC
Gate Drain Charge	Q _{GD}	(Note4,5)		14		nC
SOURCE- DRAIN DIODE RATINGS		ACTERISTICS				<u> </u>
Drain-Source Diode Forward Voltage	V _{SD}	IS=15A, VGS=0V			1.4	V
Diode Continuous Forward Current	Is				15	Α
Pulsed Drain-Source Current	I _{SM}				60	А
Reverse Recovery Time	t _{RR}	VGS = 0 V, ISD = 15A		900		ns
Reverse Recovery Charge	Q _{RR}	di/dt=100 A/µs (Note4,5)		5.9		uC

Note: 4. Pulse Test : Pulse width \leq 300µs, Duty cycle \leq 2%

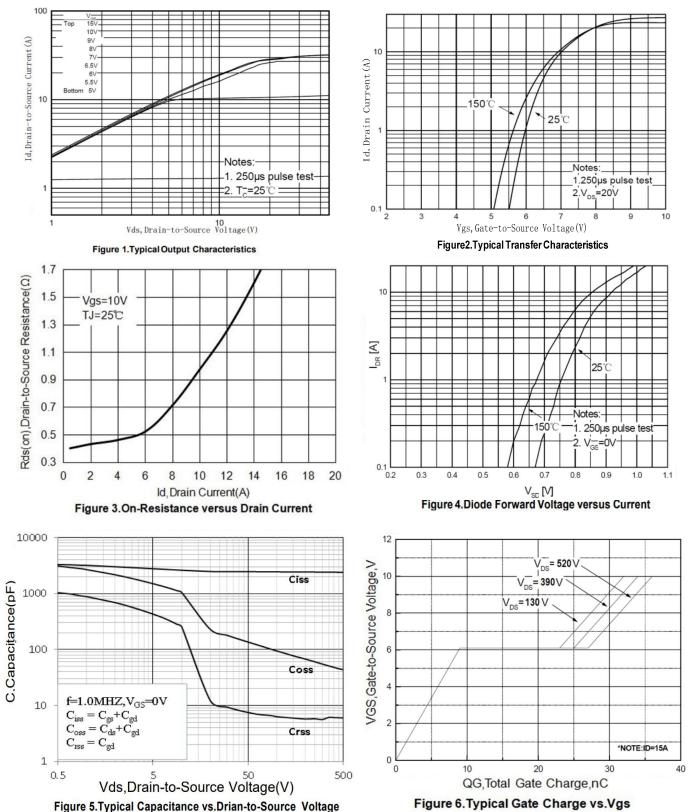
5. Essentially independent of operating temperature



Halogen Free

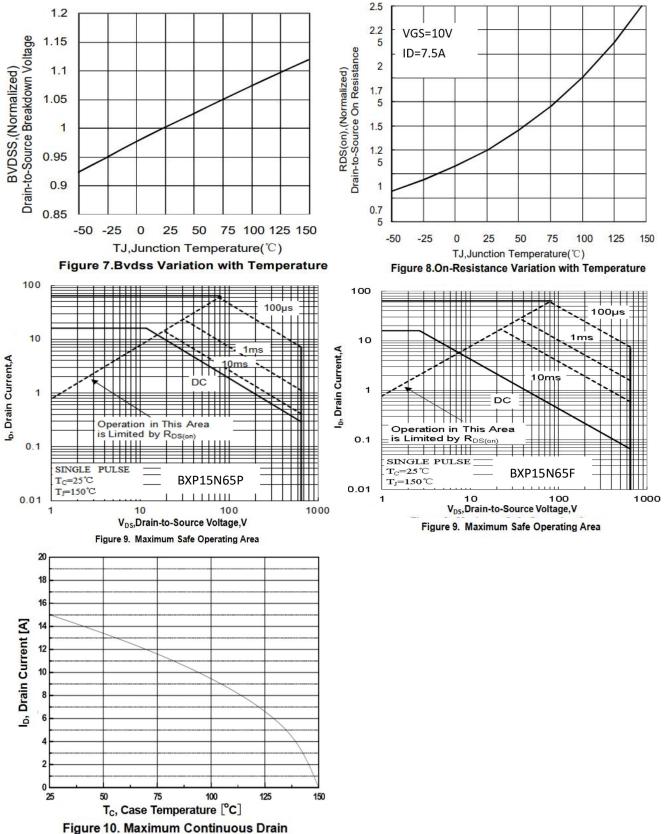
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TYPICAL CHARACTERISTICS





TYPICAL CHARACTERISTICS(Cont.)



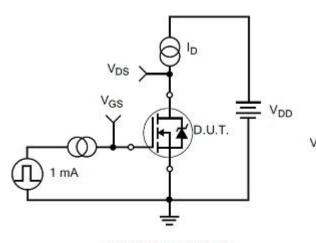
Current vs Case Temperature



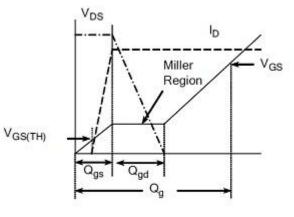
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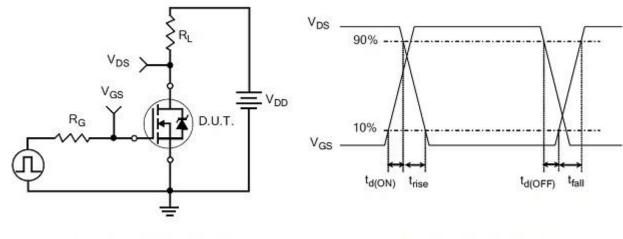
TEST CIRCUITS AND WAVEFORMS



Gate Charge Test Circuit



Gate Charge Waveform



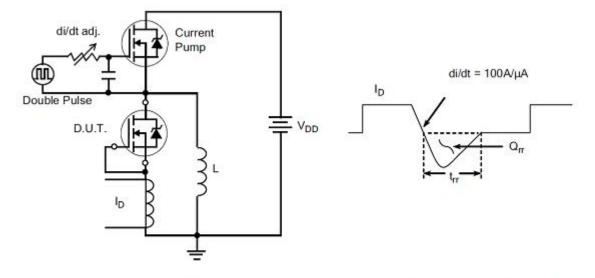
Resistive Switching Test Circuit

Resistive Switching Waveforms



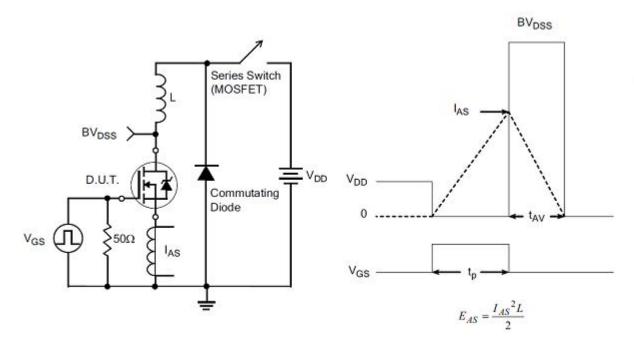
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TEST CIRCUITS AND WAVEFORMS(Cont.)



Diode Reverse Recovery Test Circuit

Diode Reverse Recovery Waveform



Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms



Revision history

Document revision history

Date	Revision	Changes
15-Aug-2021	1.0	First release
26-Aug-2021	1.1	Update picture layout format
5-Jan-2022	1.2	Update parameter

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